

line 13, replace "Exemplary" with -- Preferred --.

In the claims:

Cancel all claims without prejudice.

Add the following claims:

8. An electrical device, comprising a printed circuit board; an electronic circuit disposed at least in part on said printed circuit board and having power components each provided with an arrangement for heat dissipation; a housing frame provided with a plurality of ribs; housing frame walls, said ribs being joined to respective ones of said housing frame walls and being offset, said power components having heat-carrying housing parts kept in thermal contact on said ribs; a heat-dissipation housing bottom, said housing frame is joinable to said heat-dissipating housing bottom by thermal contact, said printed circuit board resting on a side of said housing frame which is opposite to said housing bottom.

9. An electrical device as defined in claim 8, wherein each of said ribs protrudes by a predetermined amount into a housing crosswise to a respective one of said housing frame walls.

10. An electrical device as defined in claim 8, wherein each of said ribs extends parallel to a respective one of said housing frame walls at a predetermined spacing.

11. An electrical device as defined in claim 8, wherein said housing frame is firmly screwed to said housing bottom.

12. An electrical device as defined in claim 8; and further comprising metal clamps which press said power components against said ribs.

13. An electrical device as defined in claim 8, wherein said housing bottom is a component of an electromechanical arrangement and is provided with fins for heat dissipation.

Please provide the following new abstract of the disclosure:

An electrical device has a printed circuit board, an electronic circuit disposed at least in part on the printed circuit board and having power components each provided with an arrangement for heat dissipation, a housing frame provided with a plurality of ribs, housing frame walls, the ribs being joined to respective ones of the housing frame walls and are offset, the

power components having heat-carrying housing parts kept in thermal contact on the ribs, a heat-dissipation housing bottom, the housing frame is joinable to the heat-dissipating housing bottom by thermal contact, the printed circuit board resting on a side of the housing frame which is opposite to the housing bottom.